2.5X2.0mm SURFACE MOUNT LED LAMP

PRELIMINARY SPEC

Part Number: KT-2520SE9ZS-RV Reddish-Orange

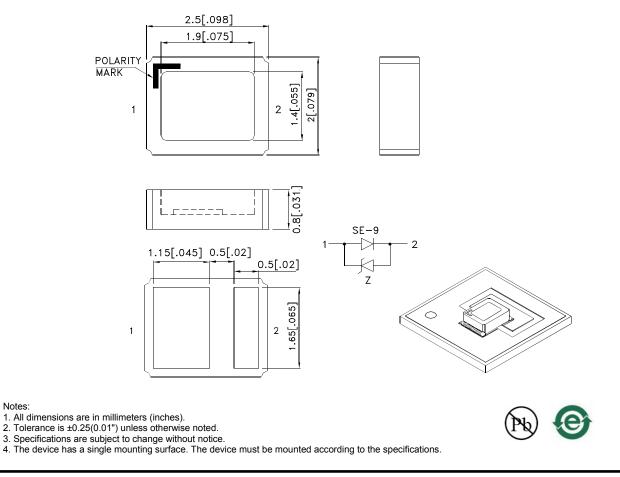
Features

- Dimension: 2.5mmx 2.0mm x 0.8mm.
- Low thermal resistance.
- Ceramic package with silicone resin.
- Small package with high efficiency.
- Surface mount technology.
- ESD protection.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 2a.
- Soldering methods: IR reflow soldering.
- RoHS compliant.

Typical Applications

PDAs Room lighting Architectural lighting Decorative/pathway lighting Front panel backlight Exterior automotive lighting: (brake lights, turn lights, backlighting)





Notes:

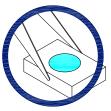
REV NO: V.3 CHECKED: Allen Liu DATE: OCT/29/2008 **DRAWN: S.P.Chen**

PAGE: 1 OF 7 ERP: 1212000004

Handling Precautions

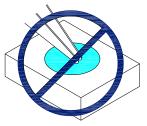
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.





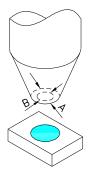
3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



4. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.

5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.

6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



Selection Guide	Dice		luminous Intensity [2] Iv(mcd)@ 350mA		Viewing Angle [1]
		Min.	Тур.	Тур.	2 0 1/2
KT-2520SE9ZS-RV	Reddish-Orange (AlGaInP)	4700	6500	18	130 °

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

Absolute Maximum Ratings at T_A = 25°C

Parameter	Symbol	Value	Unit
DC Forward Current [1]	lF	350	mA
Peak Forward Current [2]	Іғм	500	mA
Power dissipation	Pt	1.05	W
Operating Temperature	Тор	-40 To +100	°C
Storage Temperature	Tstg	-40 To +120	°C
Junction temperature[1]	TJ	120	°C
Thermal resistance [1] (Junction/ambient)	Rth j-a	95	°C/W
Thermal resistance [1] (Junction/solder point)	Rth j-s	30	°C/W
Electrostatic Discharge Threshold (HBM)		8000	V

Notes:

1. Results from mounting on PC board FR4, mounted on pc board-metal core PCB is recommend

for lowest thermal resistance.

2. 1/10 Duty Cycle, 0.1ms Pulse Width.

Electrical / Optical Characteristics at TA = 25°C

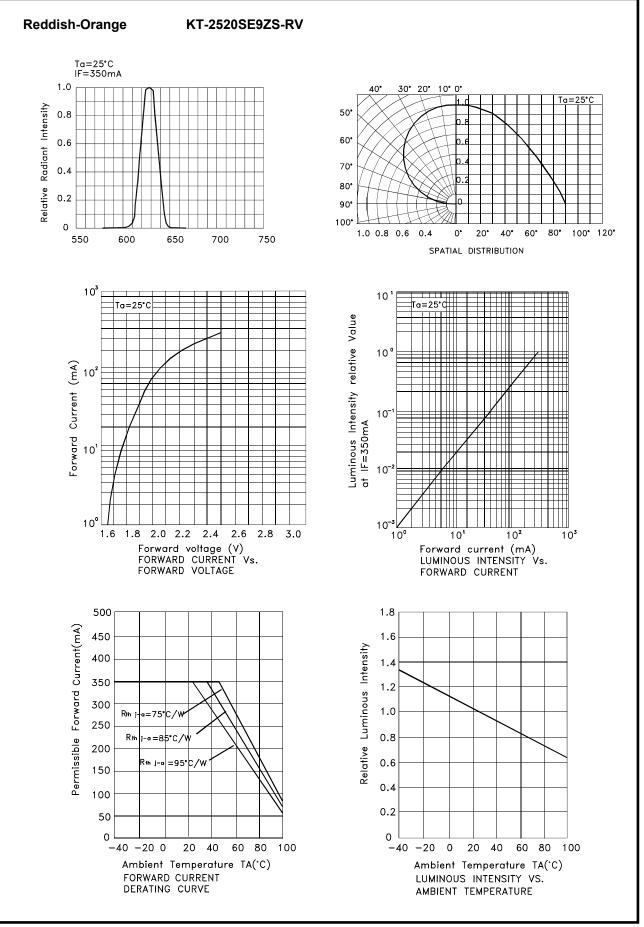
Parameter	Symbol	Value	Unit
Forward Voltage IF = 350mA [Min.]		2.0	
Forward Voltage IF = 350mA [Typ.]	VF [2]	2.5	V
Forward Voltage IF = 350mA [Max.]		3.0	
Wavelength at peak emission IF = 350mA [Typ.]	λ peak	628	nm
Dominant Wavelength I⊧ = 350mA [Typ.]	λ dom [1]	623	nm
Spectral bandwidth at 50% Φ REL MAX IF = 350mA [Typ.]	Δλ	22	nm
Temperature coefficient of λ peak IF = 350mA, - 10 $^\circ$ C \leq T \leq 100 $^\circ$ C $$ [Typ.]	TC λ peak	0.1	nm/°C
Temperature coefficient of λ dom IF = 350mA, - 10 $^\circ$ C \leq T \leq 100 $^\circ$ C [Typ.]	$TC \lambda$ dom	0.08	nm/°C
Temperature coefficient of VF IF = 350mA, - 10 $^\circ$ C \leq T \leq 100 $^\circ$ C [Typ.]	TCv	-3.0	mV/°C
Notes:			

Notes:

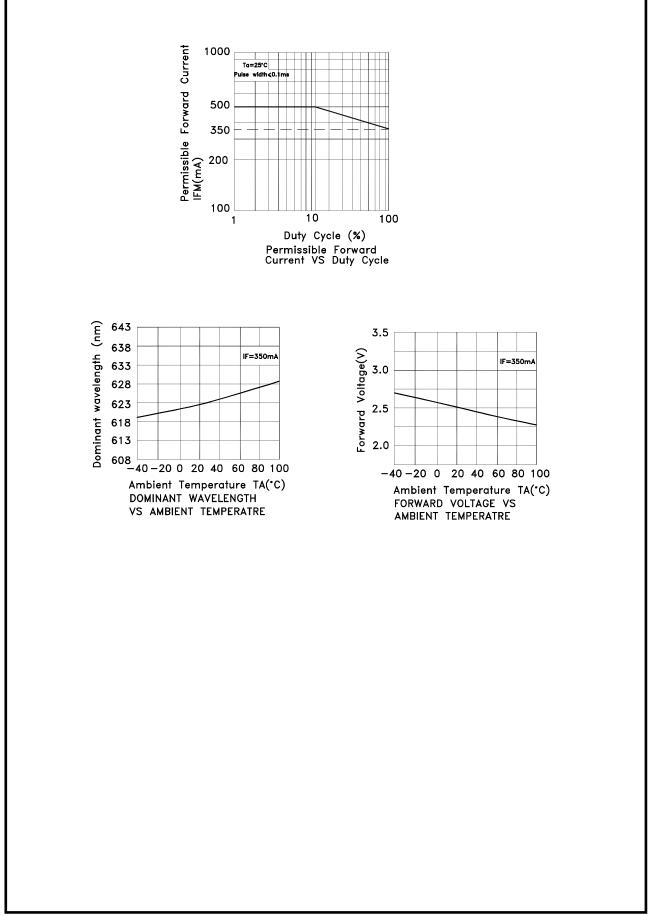
1.Wavelength : + / -1nm.

2. Forward Voltage : + / - 0.1V.

DATE: OCT/29/2008 **DRAWN: S.P.Chen**

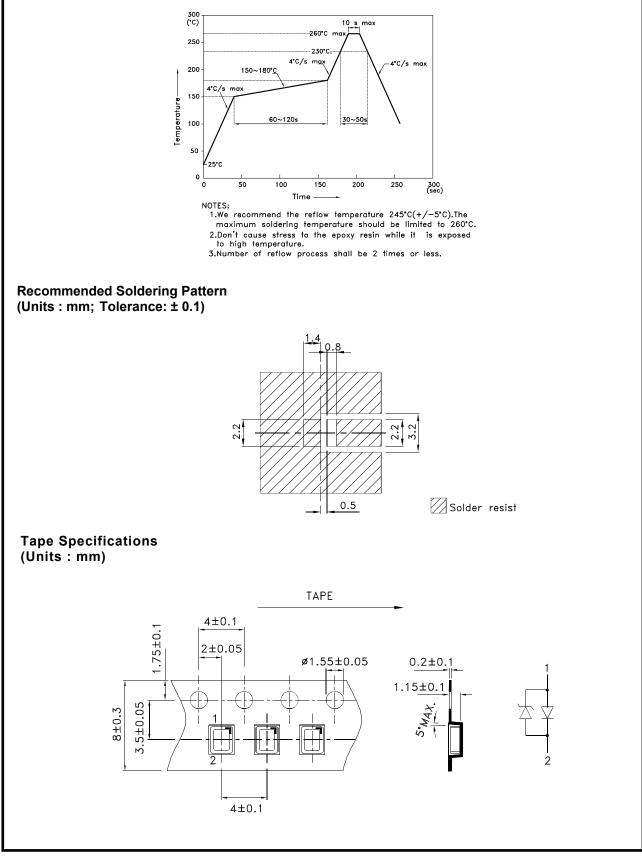


SPEC NO: DSAI6629 APPROVED: WYNEC REV NO: V.3 CHECKED: Allen Liu DATE: OCT/29/2008 DRAWN: S.P.Chen PAGE: 4 OF 7 ERP: 1212000004





Reflow Soldering Profile For Lead-free SMT Process.



REV NO: V.3 CHECKED: Allen Liu DATE: OCT/29/2008 DRAWN: S.P.Chen PAGE: 6 OF 7 ERP: 1212000004

